January 2015

## Features

- Extended $\mathrm{T}_{\mathrm{J}}$ rating to $175^{\circ} \mathrm{C}$

■ Shielded Gate MOSFET Technology
■ $\operatorname{Max} \mathrm{r}_{\mathrm{DS}(\text { on })}=7.2 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A}$
■ Max $\mathrm{r}_{\mathrm{DS}(\text { on })}=10.3 \mathrm{~m} \Omega$ at $\mathrm{V}_{\mathrm{GS}}=6 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=11.5 \mathrm{~A}$

- Advanced Package and Silicon combination for low $r_{\text {DS(on) }}$ and high efficiency
- MSL1 robust package design

■ 100\% UIL tested

- RoHS Compliant


## General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench ${ }^{\circledR}$ process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

## Application

■ DC-DC Conversion


Power 56


MOSFET Maximum Ratings $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Parameter |  |  | Ratings | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | Drain to Source Voltage |  |  | 120 | V |
| $\mathrm{V}_{G S}$ | Gate to Source Voltage |  |  | $\pm 20$ | V |
| ${ }_{\text {I }}$ | Drain Current -Continuous | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | (Note 5) | 102 | A |
|  | -Continuous | $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | (Note 5) | 72 |  |
|  | -Continuous | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | (Note 1a) | 13.5 |  |
|  | -Pulsed |  | (Note 4) | 538 |  |
| $\mathrm{E}_{\text {AS }}$ | Single Pulse Avalanche Energy |  | (Note 3) | 600 | mJ |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  | 187 | W |
|  | Power Dissipation | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | (Note 1a) | 3.3 |  |
| $\mathrm{T}_{\mathrm{J},} \mathrm{T}_{\text {STG }}$ | Operating and Storage Junction |  |  | -55 to +175 | ${ }^{\circ} \mathrm{C}$ |

## Thermal Characteristics

| $\mathrm{R}_{\theta \mathrm{JC}}$ | Thermal Resistance, Junction to Case | 0.8 |  |
| :--- | :--- | :---: | :---: |
| $\mathrm{R}_{\theta \mathrm{JJ}}$ | Thermal Resistance, Junction to Ambient | (Note 1a) | 45 |

## Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: |
| FDMS86202ET | FDMS86202ET120 | Power 56 | $13 "$ | 12 mm | 3000 units |

Electrical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

Off Characteristics

| $\mathrm{BV}_{\text {DSS }}$ | Drain to Source Breakdown Voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ | 120 |  |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\frac{\Delta \mathrm{BV}_{\mathrm{DSS}}}{\Delta \mathrm{~T}_{\mathrm{J}}}$ | Breakdown Voltage Temperature Coefficient | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$, referenced to $25^{\circ} \mathrm{C}$ |  | 103 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| IDSs | Zero Gate Voltage Drain Current | $\mathrm{V}_{\mathrm{DS}}=96 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
| IGSS | Gate to Source Leakage Current | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |  |  | $\pm 100$ | nA |

On Characteristics

| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate to Source Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 2.0 | 3.1 | 4.0 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\frac{\Delta \mathrm{V}_{\mathrm{GS}(\mathrm{th})}}{\Delta \mathrm{T}_{\mathrm{J}}}$ | Gate to Source Threshold Voltage Temperature Coefficient | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$, referenced to $25^{\circ} \mathrm{C}$ |  | -10 |  | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| ${ }^{\text {dS }}$ (on) | Static Drain to Source On Resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A}$ |  | 6.0 | 7.2 | $\mathrm{m} \Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=6 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=11.5 \mathrm{~A}$ |  | 8.1 | 10.3 |  |
|  |  | $\mathrm{V}_{G S}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | 10.9 | 13.2 |  |
| gFs | Forward Transconductance | $\mathrm{V}_{\mathrm{DS}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A}$ |  | 44 |  | S |

## Dynamic Characteristics

| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\begin{aligned} & V_{D S}=60 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \\ & \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ |  | 3275 | 4585 | pF |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  |  | 460 | 644 | pF |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  |  | 17 | 30 | pF |
| $\mathrm{R}_{\mathrm{g}}$ | Gate Resistance |  | 0.1 | 0.9 | 2.7 | $\Omega$ |

Switching Characteristics

| $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | Turn-On Delay Time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=60 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{GEN}}=6 \Omega \end{aligned}$ |  | 21 | 33 | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}}$ | Rise Time |  |  | 8.75 | 17.5 | ns |
| $\mathrm{t}_{\mathrm{d} \text { (off) }}$ | Turn-Off Delay Time |  |  | 27.2 | 44 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time |  |  | 6.1 | 12.2 | ns |
| $\mathrm{Q}_{\mathrm{g}}$ | Total Gate Charge | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ to 10 V |  | 45 | 64 | nC |
| $\mathrm{Q}_{\mathrm{g}}$ | Total Gate Charge | $\mathrm{I}_{\mathrm{D}}=13.5 \mathrm{~A}$ |  | 29 | 41 | nC |
| $\mathrm{Q}_{\mathrm{gs}}$ | Gate to Source Charge |  |  | 14.3 |  | nC |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate to Drain "Miller" Charge |  |  | 9.5 |  | nC |

Drain-Source Diode Characteristics

| $\mathrm{V}_{\text {SD }}$ | Source to Drain Diode Forward Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=2.1 \mathrm{~A}$ | (Note 2) | 0.69 | 1.2 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=13.5 \mathrm{~A}$ | (Note 2) | 0.76 | 1.3 |  |
| $\mathrm{trr}^{\text {r }}$ | Reverse Recovery Time | $\mathrm{I}_{\mathrm{F}}=13.5 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 79 | 127 | ns |
| $\mathrm{Q}_{\text {rr }}$ | Reverse Recovery Charge |  |  | 140 | 224 | nC |

Notes:

1. $R_{\theta J A}$ is determined with the device mounted on a $1 \mathrm{in}^{2}$ pad 2 oz copper pad on a $1.5 \times 1.5 \mathrm{in}$. board of FR-4 material. $R_{\theta C A}$ is determined by the user's board design.


Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted


Figure 1. On Region Characteristics


Figure 3. Normalized On Resistance vs Junction Temperature


Figure 5. Transfer Characteristics


Figure2. Normalized On-Resistance vs Drain Current and Gate Voltage


Figure 4. On-Resistance vs Gate to Source Voltage


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted


Figure 7. Gate Charge Characteristics


Figure9. Unclamped Inductive Switching Capability


Figure 11. Forward Bias Safe Operating Area


Figure8. Capacitancevs Drain to Source Voltage


Figure 10. Maximum Continuous Drain Current vs Case Temperature


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted


Figure 13. Junction-to-Ambient Transient Thermal Response Curve


LAND PATTERN
RECOMMENDATION


NOTES: UNLESS OTHERWISE SPECIFIED
A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. AA,
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10 MM .
D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
E) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.
F) DRAWING FILE NAME: PQFN08JREV3.


## DETAIL A

SCALE: 2:1

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| :---: | :---: | :---: | :---: |
| AttitudeEngine ${ }^{\text {TM }}$ | FRFET ${ }^{\circledR}$ |  | $\checkmark$ GENERAL |
| Awinda ${ }^{\text {® }}$ | Global Power Resource ${ }^{\text {SM }}$ | ${ }^{(8)}$ | TinyBoost ${ }^{\text {® }}$ |
| AX-CAP ${ }^{\text {® }}$ * | GreenBridge ${ }^{\text {TM }}$ | Power Supply WebDesigner ${ }^{\text {TM }}$ | TinyBuck ${ }^{\text {® }}$ |
| BitSiC ${ }^{\text {™ }}$ | Green FPS ${ }^{\text {™ }}$ | PowerTrench ${ }^{\text {® }}$ | TinyCalc ${ }^{\text {™ }}$ |
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| CROSSVOLT ${ }^{\text {TM }}$ | IntellimAX ${ }^{\text {TM }}$ | $\mathrm{QS}^{\text {™ }}$ | TinyPWM ${ }^{\text {™ }}$ |
| CTL ${ }^{\text {™ }}$ | ISOPLANAR ${ }^{\text {™ }}$ | Quiet Series ${ }^{\text {TM }}$ | TinyWire ${ }^{\text {TM }}$ |
| Current Transfer Logic ${ }^{\text {TM }}$ | Making Small Speakers Sound Louder | RapidConfigure ${ }^{\text {TM }}$ | TranSiC ${ }^{\text {™ }}$ |
| DEUXPEED ${ }^{\text {® }}$ | and Better ${ }^{\text {TM }}$ | ( ${ }^{\text {TM }}$ | TriFault Detect ${ }^{\text {TM }}$ |
| Dual Cool ${ }^{\text {TM }}$ | MegaBuck ${ }^{\text {™ }}$ |  | TRUECURRENT ${ }^{\text {® }}$ * |
| EcoSPARK ${ }^{\text {® }}$ | MICROCOUPLER ${ }^{\text {TM }}$ | Saving our world, $1 \mathrm{~mW} / \mathrm{W} / \mathrm{kW}$ at a time ${ }^{\text {TM }}$ | $\mu$ SerDes $^{\text {TM }}$ |
| EfficientMax ${ }^{\text {TM }}$ | MicroFET ${ }^{\text {TM }}$ | SignalWise ${ }^{\text {TM }}$ |  |
| ESBC ${ }^{\text {™ }}$ | MicroPak ${ }^{\text {M }}$ | SmartMax ${ }^{\text {TM }}$ SMART START ${ }^{\text {TM }}$ | SerDes* |
| $\Gamma^{\circledR}$ | MicroPak2 ${ }^{\text {™ }}$ | SMART START ${ }^{\text {TM }}$ Solution for Your Success ${ }^{\text {TM }}$ | $\mathrm{UHC}^{\circledR}$ |
| Fairchild ${ }^{\text {® }}$ | MillerDrive ${ }^{\text {TM }}$ | Solutions for Your Success ${ }^{\text {TM }}$ SPM ${ }^{\text {® }}$ | Ultra FRFET ${ }^{\text {TM }}$ |
| Fairchild Semiconductor ${ }^{\text {® }}$ | MotionMax ${ }^{\text {™ }}$ | STEALTH ${ }^{\text {TM }}$ | UniFET ${ }^{\text {m }}$ |
| FACT Quiet Series ${ }^{\text {TM }}$ | MotionGrid ${ }^{\text {® }}$ | SuperFET ${ }^{\text {® }}$ | VCX ${ }^{\text {TM }}$ |
| $\mathrm{FACT}^{\text {® }}$ | MTi ${ }^{\text {® }}$ | SuperSOT ${ }^{\text {mm-3 }}$ | VisualMax ${ }^{\text {TM }}$ |
| FastvCore ${ }^{\text {TM }}$ | MVN ${ }^{\text {M }}$ | SuperSOT ${ }^{\text {TM }}$-6 | VoltagePlus ${ }^{\text {TM }}$ |
| FETBench ${ }^{\text {™ }}$ | mWSaver ${ }^{\text {® }}$ | SuperSOT ${ }^{\text {TM }}$-8 | Xsens ${ }^{\text {m }}$ |
| FPS ${ }^{\text {™ }}$ | OptoHiT ${ }^{\text {TM }}$ | SupreMOS ${ }^{\text {S }}$ S ${ }^{\text {® }}$ | 仙童 ${ }^{\circledR}$ |
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